

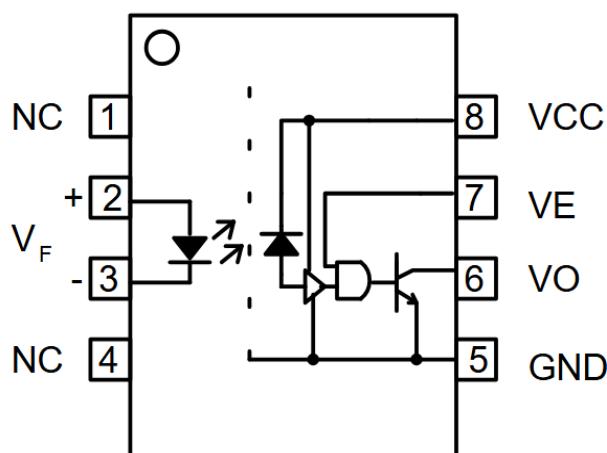
Darlington High Speed Transistor Photo Coupler

Description

The 6N138/ 6N139 consists of a high efficient AlGaAs Light Emitting Diode and a high speed optical detector.

This design provides excellent AC and DC isolation between the input and output sides of the Optocoupler. Connection for the bias of the photodiode improves the speed that of a conventional phototransistor coupler by reducing the base-collector capacitances.

Functional Diagram



6N138/6N139

Features

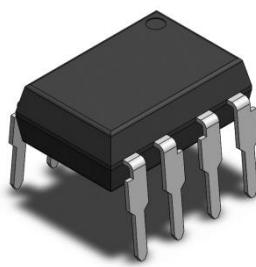
- High isolation 5000 VRMS
- Logic gate output
- Operating temperature range - 55 °C to 100 °C
- Wired or-open collector

Applications

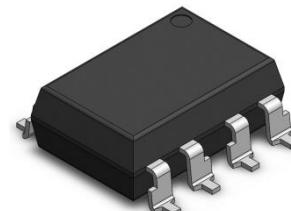
- Date Multiplexing
- Current loop receivers
- Out interface to CMOS-LSTTL-TTL
- Pulse transformer replacement
- Computer-peripheral interface

Truth Table (Positive Logic)

LED	VO
ON	LOW
OFF	HIGH



6N138 6N139/DIP-8



6N138S 6N139S/SMD-8

ABSOLUTE MAXIMUM RATINGS (TA = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	Note
Forward Current	I _F	25	mA	
Peak Forward Current	I _{FP}	50	mA	1
Peak Transient Current	I _{F(trans)}	1	A	2
Reverse Voltage	V _R	5	V	
Input Power Dissipation	P _I	100	mW	
Supply Voltage	V _{CC}	-0.5~18	V	
Output Voltage	V _O	-0.5~18	V	
Output Current	I _O	60	mA	
Emitter-Base Reverse Voltage	V _{EVR}	0.5	V	
Output Power Dissipation	P _O	100	mW	
Total Power Dissipation	P _{tot}	200	mW	
Isolation Voltage	V _{iso}	5000	Vrms	3
Operating Temperature	T _{opr}	-55~100	°C	
Storage Temperature	T _{stg}	-55~150	°C	
Soldering Temperature	T _{sol}	260	°C	4

Note 1. 50% duty, 1ms P.W

Note 2. ≤1μs P.W,300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds

ELECTRICAL OPTICAL CHARACTERISTICS								
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE	
INPUT(at Ta=0 to 70°C , unless specified otherwise)								
Forward Voltage	V _F	-	1.28	1.7	V	I _F =1.6mA		
Reverse Current	I _R	-	-	10	µA	V _R =5V		
Input Capacitance	C _{in}	-	60	-	pF	V=0, f=1MHz		
OUTPUT(at Ta=0 to 70°C , unless specified otherwise)								
High Level Supply Current	I _{CCH}	-	0.05	10	µA	I _F =0mA, V _O =Open, V _{CC} =18V		
Low Level Supply Current	I _{CCL}	-	0.6	1.5	mA	I _F =1.6mA, V _O =Open, V _{CC} =18V		
Logic High Output Current	6N138	I _{OH}	-	0.01	100	µA	I _F =0mA, V _O =V _{CC} =18V,	
	6N139		-	-	250	µA		
TRANSFER CHARACTERISTICS(at Ta=0 to 70°C , unless specified otherwise)								
Current Transfer Ratio	6N139	CTR	400	2500	-	%	I _F = 0.5mA ,V _O = 0.4V, V _{CC} =4.5V	
			500	2600	-		I _F = 1.6mA ,V _O = 0.4V, V _{CC} =4.5V	
			300	2600	-		I _F = 0.5mA ,V _O = 0.4V, V _{CC} =4.5V	
Logic Low Output Voltage	6N139	V _{OL}	-	0.04	0.4	V	I _F = 0.5mA ,I _O = 2mA, V _{CC} =4.5V	
			-	0.07	0.4		I _F = 1.6mA ,I _O = 8mA, V _{CC} =4.5V	
			-	0.11	0.4		I _F = 5mA ,I _O = 15mA, V _{CC} =4.5V	
			-	0.15	0.4		I _F = 12mA ,I _O = 24mA, V _{CC} =4.5V	
			-	0.05	0.4		I _F = 1.6mA ,I _O = 4.8mA, V _{CC} =4.5V	
Isolation Resistance		R _{iso}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C _{IO}	-	0.3	1	pF	V=0, f=1MHz	

ELECTRICAL OPTICAL CHARACTERISTICS							
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
TRANSFER CHARACTERISTICS(at Ta=0 to 70°C , unless specified otherwise)							
Current Transfer Ratio	6N139	CTR	400	2500	-	%	$I_F = 0.5mA, V_O = 0.4V,$ $V_{CC}=4.5V$
			500	2600	-		$I_F = 1.6mA, V_O = 0.4V,$ $V_{CC}=4.5V$
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Logic Low Output Voltage	6N139	V_{OL}	-	0.04	0.4	V	$I_F = 0.5mA, I_O = 2mA, V_{CC}=5V$
			-	0.07	0.4		$I_F = 1.6mA, I_O = 8mA,$ $V_{CC}=4.5V$
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			-	0.15	0.4		$I_F = 12mA, I_O = 24mA,$ $V_{CC}=4.5V$
			-	0.05	0.4		$I_F = 1.6mA, I_O = 4.8mA,$ $V_{CC}=4.5V$
Isolation Resistance	Riso	10^{12}	10^{14}	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C_{IO}	-	0.3	1	pF	$V=0, f=1MHz$	

ELECTRICAL OPTICAL CHARACTERISTICS								
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE	
SWITCHING CHARACTERISTICS(at Ta=0 to 70°C,V _{CC} =5V, unless specified otherwise)								
Propagation Delay Time to Logic Low	6N139	TPHL	-	5	25	μs	$I_F = 0.5\text{mA}, R_L = 4.7\text{k}\Omega, T_A = 25^\circ\text{C}$	
			-	-	30		$I_F = 0.5\text{mA}, R_L = 4.7\text{k}\Omega$	
			-	0.2	1		$I_F = 12\text{mA}, R_L = 270\Omega, T_A = 25^\circ\text{C}$	
			-	-	2		$I_F = 12\text{mA}, R_L = 270\Omega$	
	6N138		-	1.4	10		$I_F = 1.6\text{mA}, R_L = 2.2\text{k}\Omega, T_A = 25^\circ\text{C}$	
			-	-	15		$I_F = 1.6\text{mA}, R_L = 2.2\text{k}\Omega$	
			-	22	60		$I_F = 0.5\text{mA}, R_L = 4.7\text{k}\Omega, T_A = 25^\circ\text{C}$	
Propagation Delay Time to Logic High	6N139	TPLH	-	-	90	μs	$I_F = 0.5\text{mA}, R_L = 4.7\text{k}\Omega$	
			-	2.1	7		$I_F = 12\text{mA}, R_L = 270\Omega, T_A = 25^\circ\text{C}$	
			-	-	10		$I_F = 12\text{mA}, R_L = 270\Omega$	
	6N138		-	10.7	35		$I_F = 1.6\text{mA}, R_L = 2.2\text{k}\Omega, T_A = 25^\circ\text{C}$	
			-	-	50		$I_F = 1.6\text{mA}, R_L = 2.2\text{k}\Omega$	
			-	22	60		$I_F = 0.5\text{mA}, R_L = 4.7\text{k}\Omega, T_A = 25^\circ\text{C}$	
Common Mode Transient Immunity at Logic High	6N139	CM _H	1000	-	-	$\text{V}/\mu\text{s}$	$I_F = 0\text{mA}, V_{CM} = 10\text{Vpp}, RL = 2.2\text{k}\Omega, T_A = 25^\circ\text{C}$	
	6N138		1000	-	-			
Common Mode Transient Immunity at Logic Low	6N139	CM _L	1000	-	-	$\text{V}/\mu\text{s}$	$I_F = 1.6\text{mA}, V_{CM} = 10\text{Vpp}, RL = 2.2\text{k}\Omega, T_A = 25^\circ\text{C}$	
	6N138		1000	-	-			

Fig.13

Fig.13

Fig.15

Fig.15

CHARACTERISTIC CURVES

Fig.1 Low Level Output Current vs. Forward Current

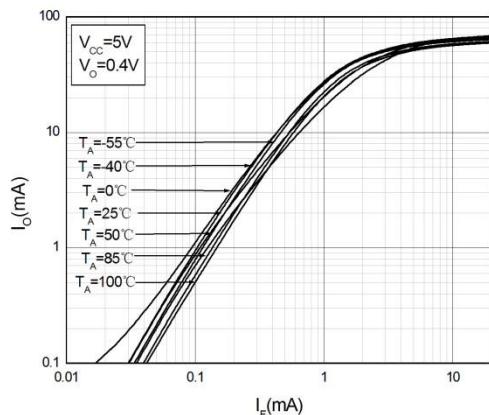


Fig.2 Low Level Output Current vs. Output Voltage

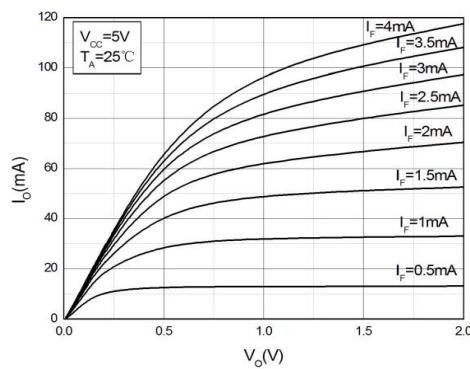


Fig.3 Current Transfer Ratio vs. Base-Emitter Resistance

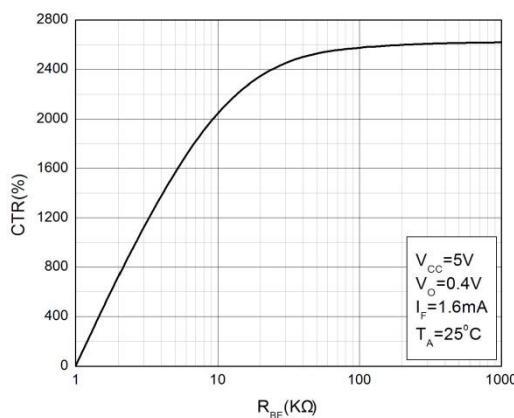


Fig.4 Normalized Current Transfer Ratio vs. Ambient Temperature

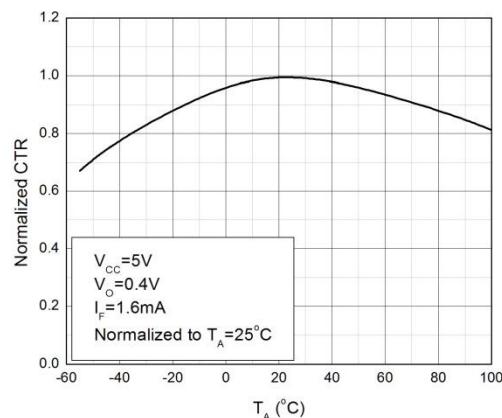


Fig.5 Current Transfer Ratio vs. Forward Current

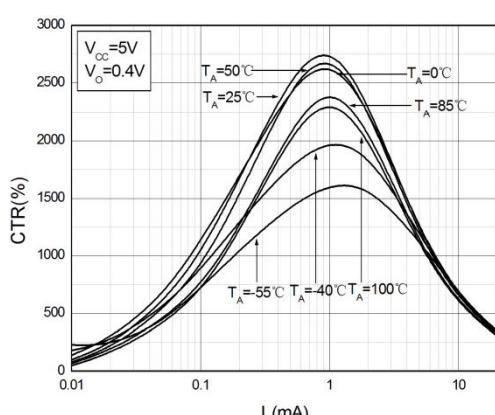
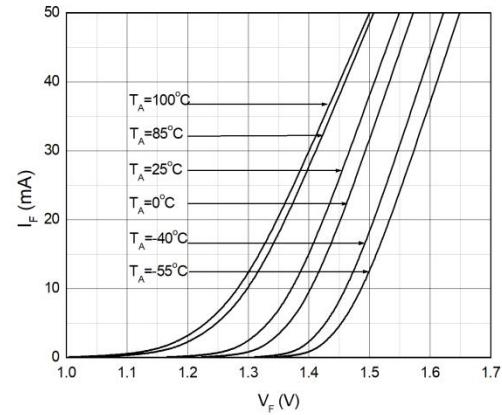
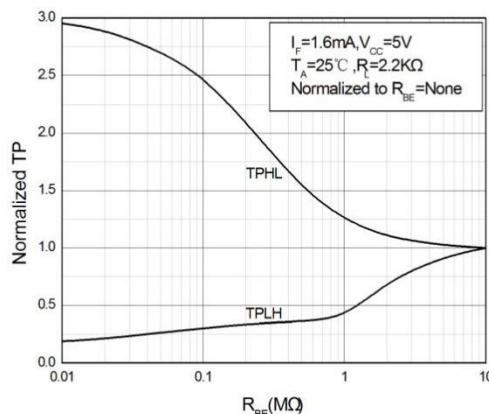
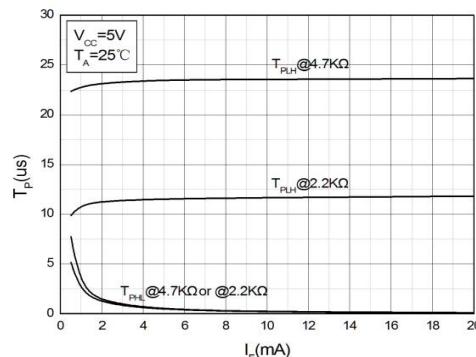
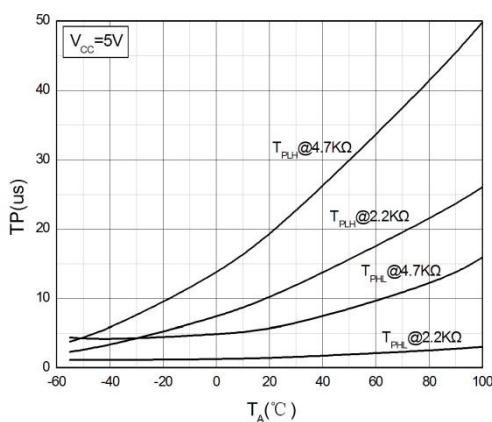
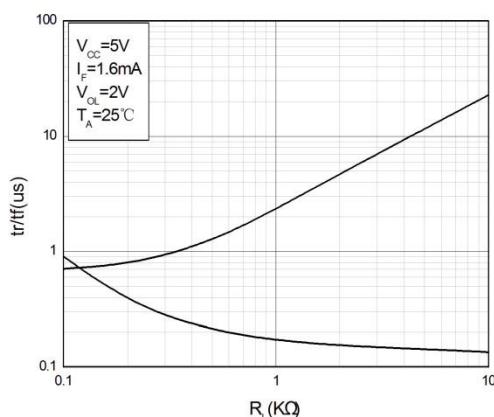
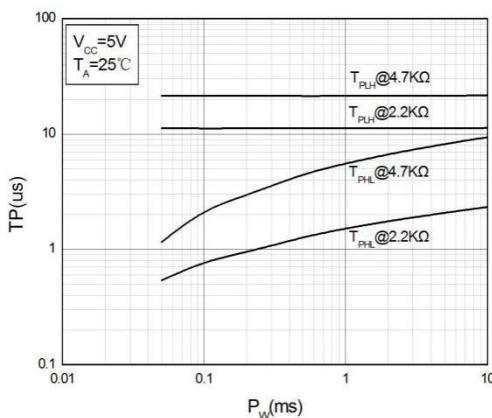
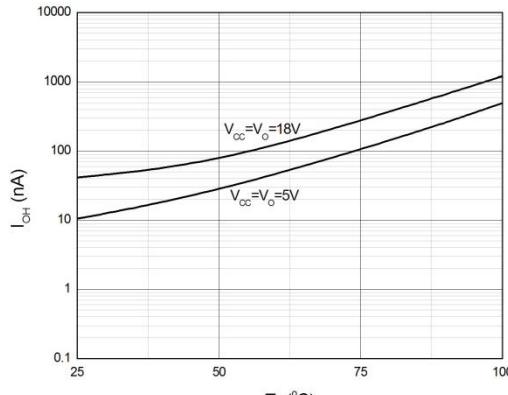


Fig.6 Forward Current vs. Forward Voltage



CHARACTERISTIC CURVES

**Fig.7 Propagation Delay
vs. Base-Emitter Resistance****Fig.8 Propagation Delay
vs. Forward Current****Fig.9 Propagation Delay
vs. Ambient Temperature****Fig.10 Rise and Fall Time
vs. Load Resistance****Fig.11 Propagation Delay
vs. Pulse Width****Fig.12 High Level Output Current
vs. Ambient Temperature**

TEST CIRCUITS

Fig.13 Test Circuits for TPHL, TPLH, tr, tf

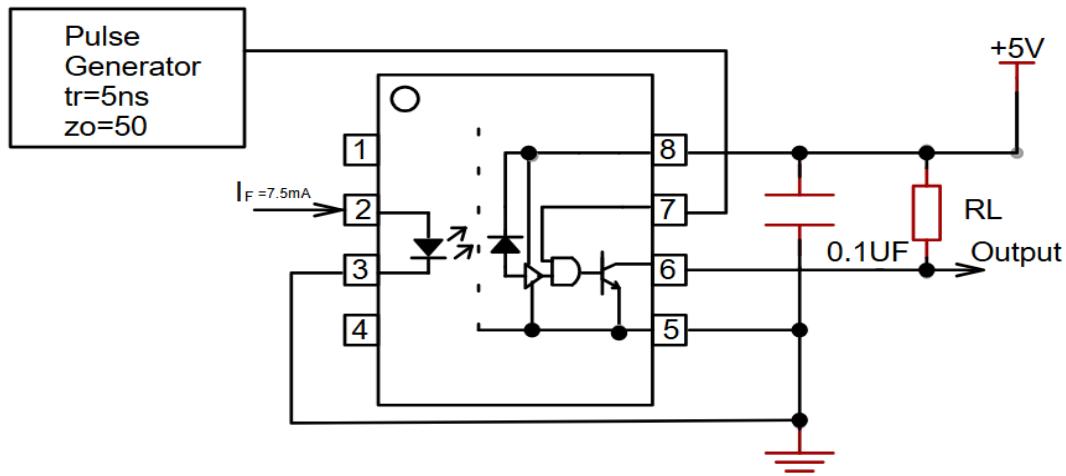
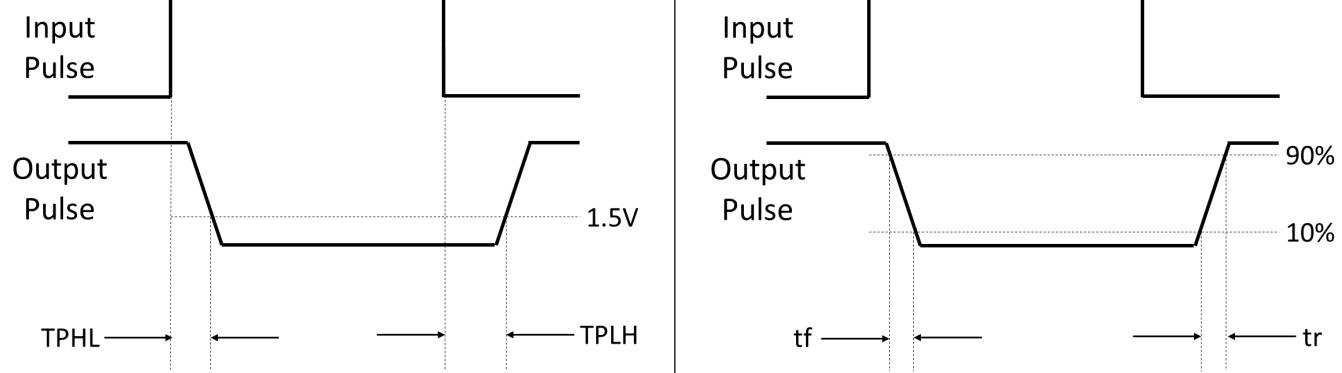


Fig.14 Waveforms of TPHL, TPLH, tr, tf



TEST CIRCUITS

Fig.15 Test Circuits for Common Mode Transient Immunity

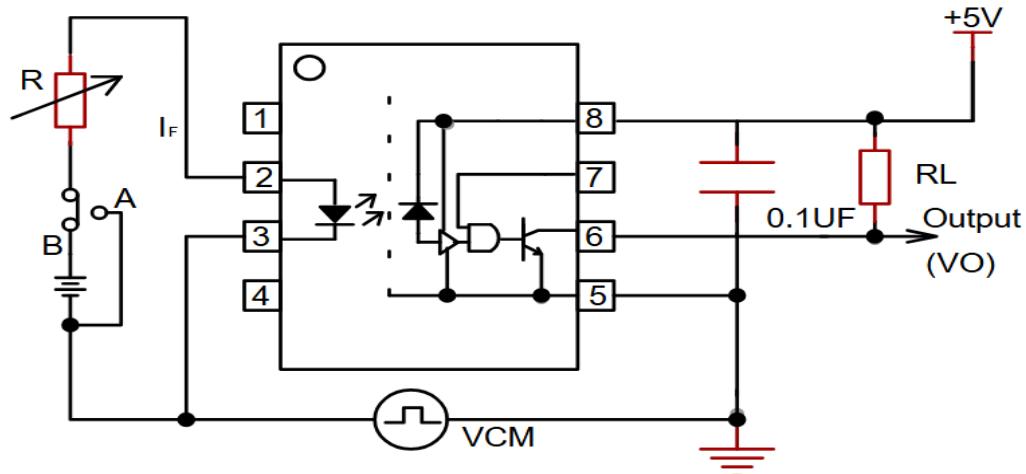
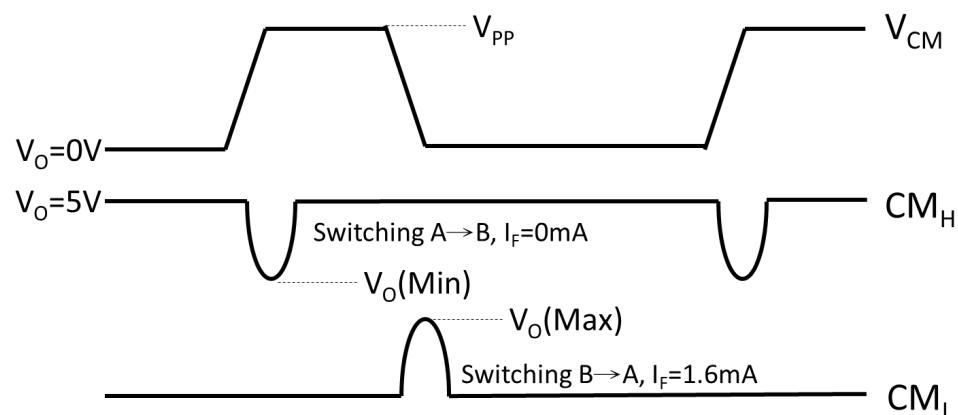
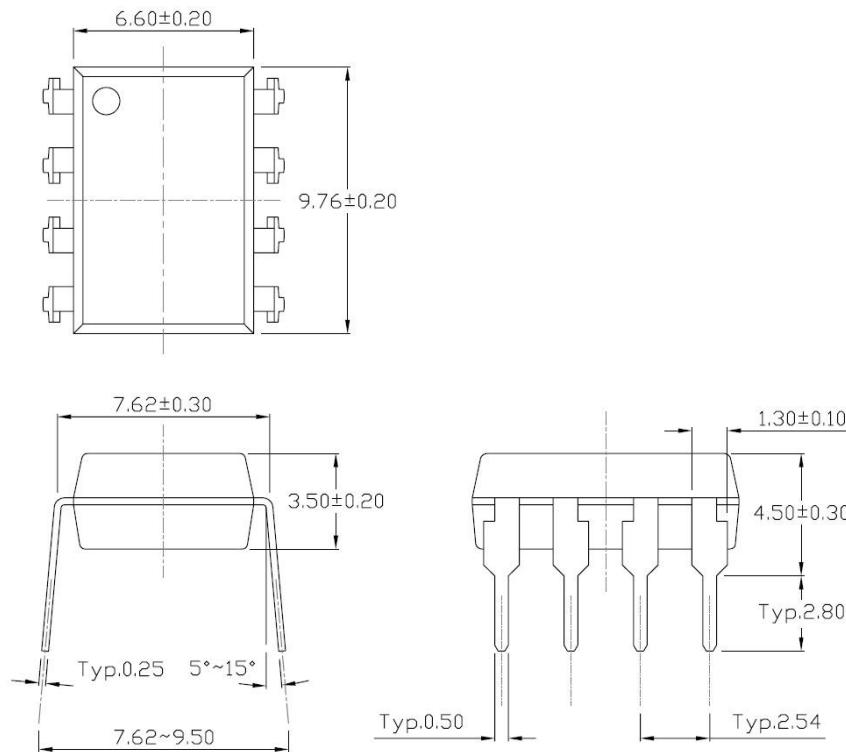


Fig.16 Waveforms of Common Mode Transient Immunity

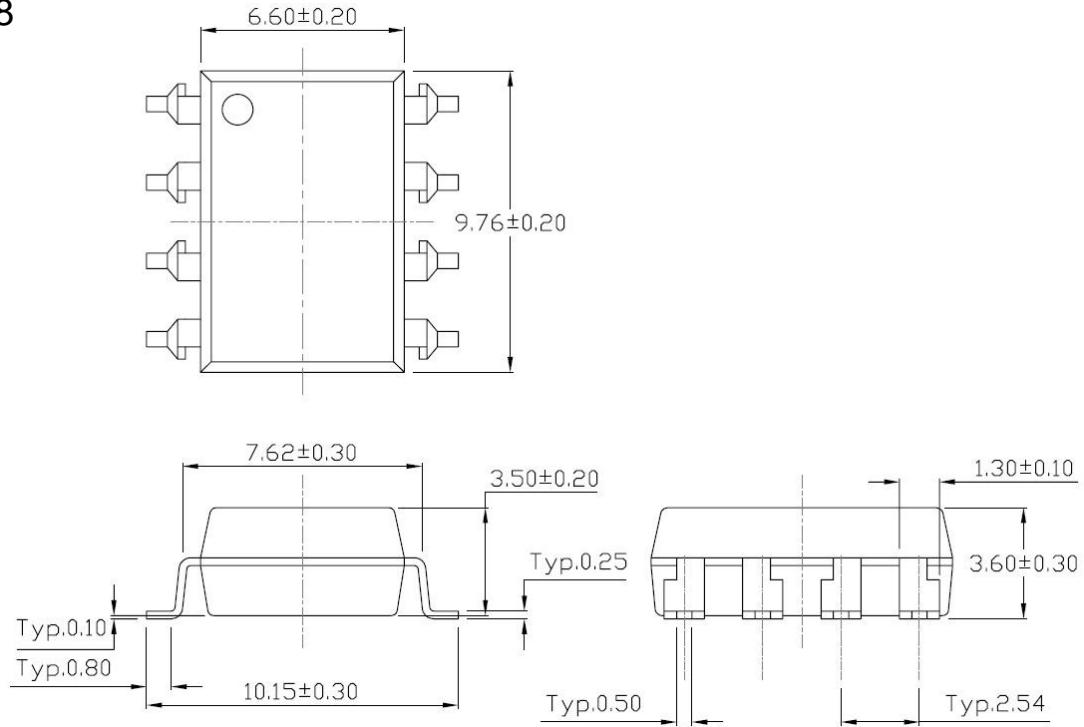


PACKAGE DIMENSIONS Dimensions in mm unless otherwise stated

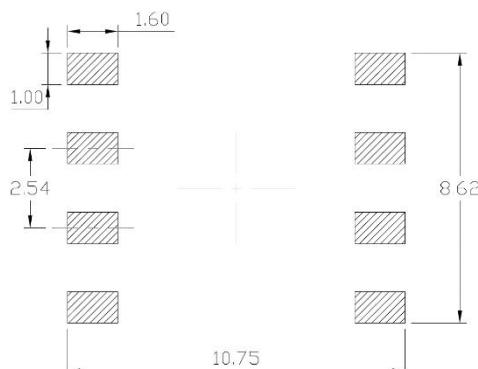
DIP-8



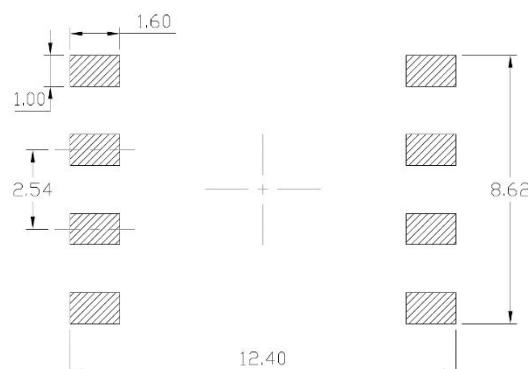
SMD-8



Recommended Solder Mask Dimensions in mm unless otherwise stated

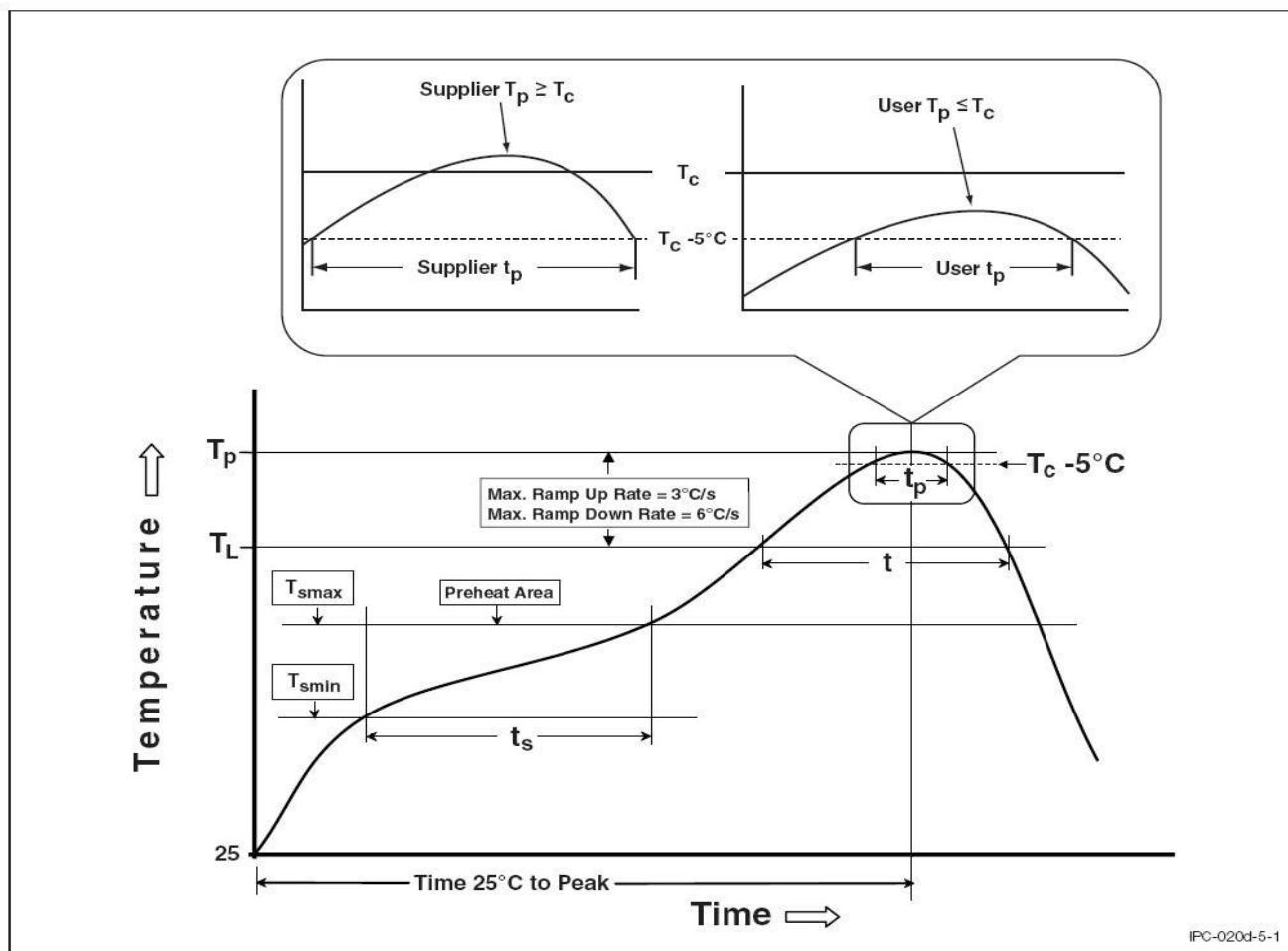


Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



Surface Mount (Gullwing) Lead Forming

REFLOW INFORMATION



REFLOW PROFILE

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to t_P)	$3^{\circ}\text{C}/\text{second max.}$	$3^{\circ}\text{C}/\text{second max.}$
Liquidous Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	$235^{\circ}\text{C} +0^{\circ}\text{C} / -5^{\circ}\text{C}$	$260^{\circ}\text{C} +0^{\circ}\text{C} / -5^{\circ}\text{C}$
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	$6^{\circ}\text{C}/\text{second max}$	$6^{\circ}\text{C}/\text{second max}$
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.